

TRANSMITTAL

Electronic Version v1.1

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Title of Invention	HDP PROCESS FOR HIGH ASPECT RATIO GAP FILLING							
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Michael P. Belyansky</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: FIS920030085</p>								
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>Steven Capella Registered Number: 33086</td><td>Steven Capella</td><td>Attorney</td></tr></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Steven Capella Registered Number: 33086	Steven Capella	Attorney
Submitted By:	Elec. Sign.	Sign. Capacity						
Steven Capella Registered Number: 33086	Steven Capella	Attorney						

Documents being submitted:	Files
us-fee-sheet	Fls920030085US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-ids	Fls920030085US1-usidst.xml us-ids.dtd us-ids.xsl
us-request	Fls920030085US1-usrequ.xml us-request.dtd us-request.xsl
us-assignment	Fls920030085US1-usassn.xml us-assignment.xsl us-assignment.dtd FIS920030085US1assignIBM1.tif FIS920030085US1assignIBM2.tif FIS920030085US1assignINF1.tif FIS920030085US1assignAMAT1.tif FIS920030085US1dec1.tif FIS920030085US1dec2.tif FIS920030085US1dec3.tif FIS920030085US1-trans.xml us-application-body.xsl application-body.dtd
us-declaration	wipo.ent
us-declaration	mathml2.dtd
us-declaration	mathml2-qname-1.mod
application-body	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogr3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
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	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
	mmlextra.ent
	mmlalias.ent
	soextblx.dtd
	FIS920030085sheet1.tif
	FIS920030085sheet2.tif

us-declaration	FIS920030085sheet3.tif FIS920030085US1dec4.tif
Comments	
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